

INTERNATIONAL  
GEMOLOGICAL  
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

November 19, 2025

IGI Report Number

Description

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

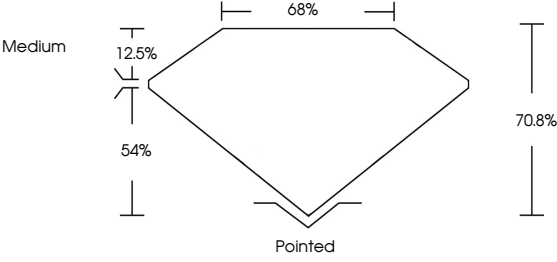
Inscription(s)

Comments: As Grown - No indication of post-growth treatment.  
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

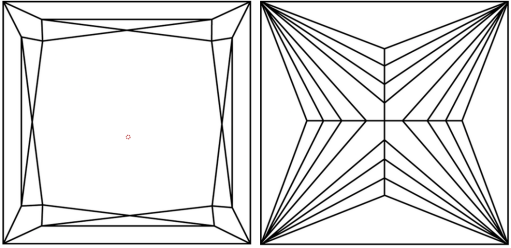
LG739579972

Report verification at [igi.org](#)

PROPORTIONS




CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.  
Green symbols indicate external characteristics.



Sample Image Used

COLOR

D	E	F	G	H	I	J	Faint	Very Light	Light
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CLARITY

FL	IF	VVS <sup>1-2</sup>	VS <sup>1-2</sup>	SI <sup>1-2</sup>	I <sup>1-3</sup>
Flawless	Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	Included

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

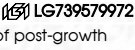
Inscription(s)


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EXCELLENT

EXCELLENT

NONE

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IGI

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PRINCESS CUT

5.57 X 5.48 X 3.88 MM

1.04 CARAT

D

VVS 1

70.8%

68%


Medium

Pointed

EXCELLENT

EXCELLENT


NONE

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